

<b>Notice of References Cited</b>	Application/Control No. 10/624,203	Applicant(s)/Patent Under Reexamination GRUDOWSKI, PAUL A.	
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**NON-PATENT DOCUMENTS**

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	U	Wolf and Tauber; Silicon Processing for the VLSI Era Volume 1: Process Technology; Lattice Press, 1986, page 192
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\*A copy of this reference is not being furnished with this Office action. (See MPEP § 707.05(a).)  
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